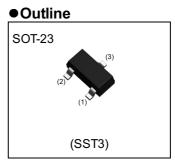


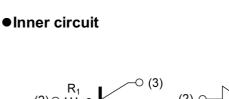
PNP -500mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

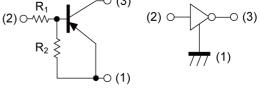
Parameter	Value
V <sub>CC</sub>	-50V
I <sub>C(MAX.)</sub>	-500mA
R <sub>1</sub>	10kΩ
R <sub>2</sub>	10kΩ



## Features

- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 10k\Omega$
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Type: DTD114EC





(1) GND (+) (EMITTER)(2) IN (BASE)(3) OUT (COLLECTOR)

## Application

INVERTER, INTERFACE, DRIVER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTB114EC	SOT-23 (SST3)	2924	T116	180	8	3000	F14

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Values	Unit
Supply voltage	V <sub>CC</sub>	-50	V
Input voltage	V <sub>IN</sub>	-40 to 10	V
Collector current	I <sub>C(MAX)</sub> *1	-500	mA
Power dissipation	P <sub>D</sub> *2	200	mW
Junction temperature	Τj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Deremeter	O: make al	Conditions	Values			1.134	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Inputivoltogo	V <sub>I(off)</sub>	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100µA	-	-	-0.5	- v	
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = -0.3V, I <sub>O</sub> = -10mA	-3.0	-	-	v	
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -50mA, I <sub>I</sub> = -2.5mA	-	-100	-300	mV	
Input current	I	V <sub>I</sub> = -5V	-	-	-880	μA	
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = -50V, V <sub>I</sub> = 0V	-	-	-500	nA	
DC current gain	$G_{I}^{*3}$	V <sub>O</sub> = -5V, I <sub>O</sub> = -50mA	56	-	-	-	
Input resistance	R <sub>1</sub>	-	7	10	13	kΩ	
Resistance ratio	$R_2/R_1$	-	0.8	1.0	1.2	-	
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 50mA, f = 100MHz	-	200	-	MHz	

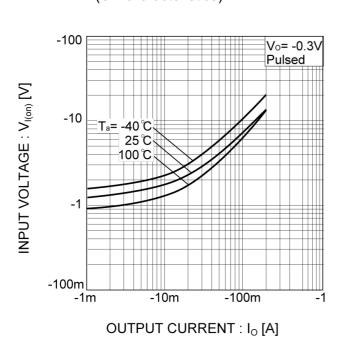
\*1 Characteristics of built-in transistor

\*2 Each terminal mounted on a reference land.

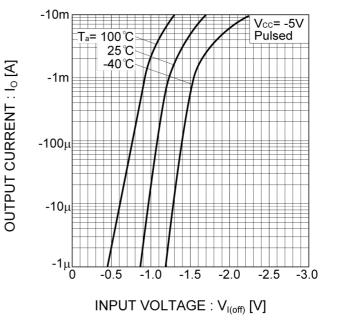
\*3 Pulsed



## •Electrical characteristic curves (T<sub>a</sub> =25°C)



# Fig.1 Input voltage vs. output current (ON characteristics)



# Fig.2 Output current vs. input voltage (OFF characteristics)

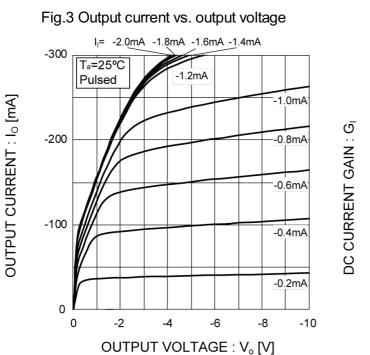
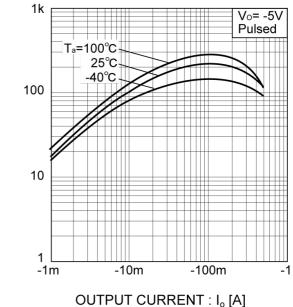
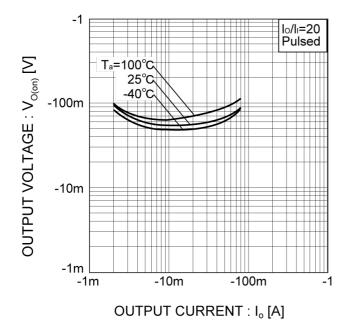


Fig.4 DC current gain vs. output current



## •Electrical characteristic curves (T<sub>a</sub> =25°C)

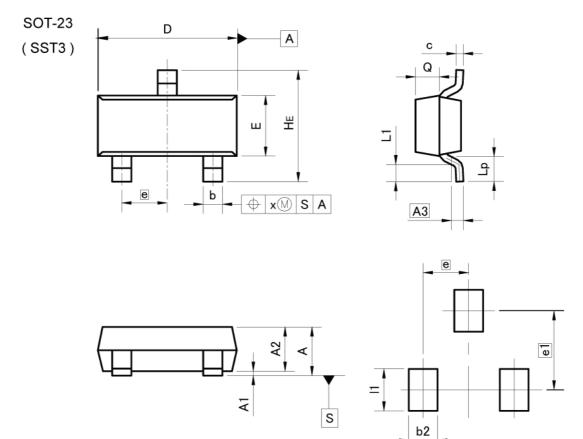


## Fig.5 Output voltage vs. output current



### DTB114EC

## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN MIN MIN		MIN	MAX	
А	0.90	1.20	0.035	0.047	
A1	0.00	0.10	0.000	0.004	
A2	0.85	1.15	0.033	0.045	
A3	0.1	25	0.0	10	
b	0.35	0.50	0.014	0.020	
С	0.09	0.25	0.004	0.010	
D	2.70	3.10	0.106	0.122	
E	1.20	1.50	0.047	0.059	
е	0.95		0.037		
HE	2.20	2.60	0.087	0.102	
L1	0.20	-	0.008		
Lp	0.30		0.012	-	
Q	0.40	0.60	0.016	0.024	
х	- ,	0.10	-	0.004	
	MILIM	ETERS	INC	HES	

DIM		INCHES		
DIN	MIN	MAX	MIN	MAX
b2	-	0.60	-	0.024
e1	1.1	70	0.0	67
1		0.90	-	0.035

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications
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JÁPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII	
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI	

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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